

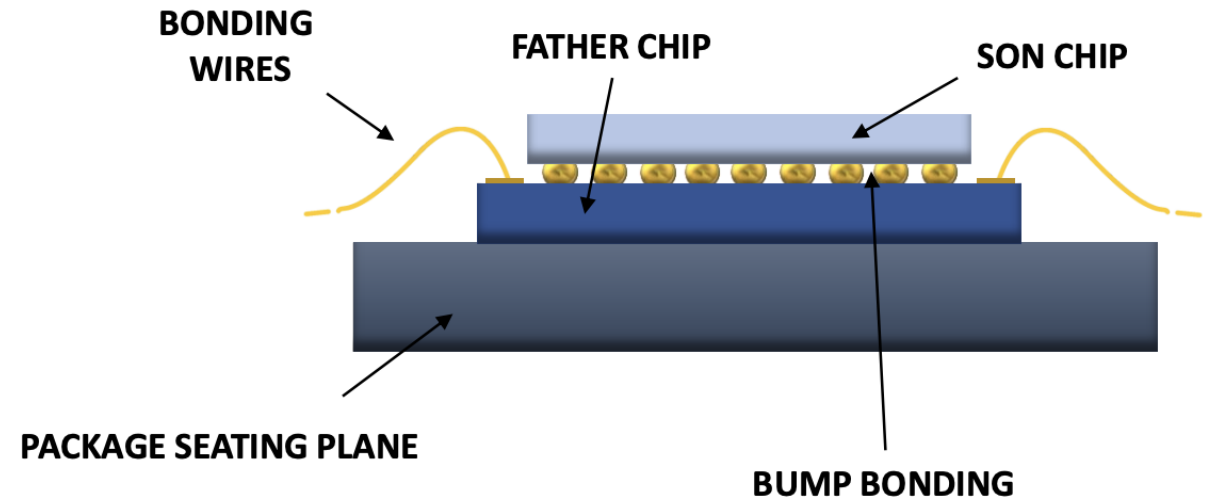
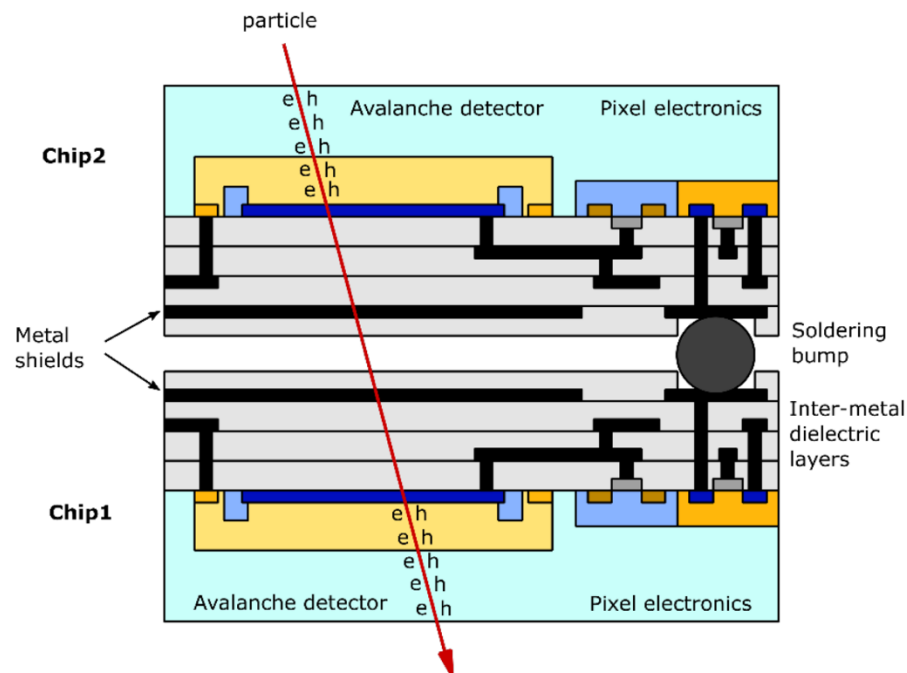
ASPiDeS

A CMOS SPAD and Digital SiPM platform for High Energy Physics

- **Goal:** develop SiPMs in CMOS technology (digital SiPMs) for fast (100 ps):
 - high dynamic range applications in dual-readout calorimetry
 - Small signals for **RICH/Cryogenics** operation for **Neutrino** physics and **DM** searches
- Participating units: Bari, Bologna, Milano, Pavia, Trento, Napoli, Padova, Torino

LF 110 nm technology

- uCell originally developed by FBK (L. Pancheri-INFN TS)
- Evolution of Apix2 (LF150nm) and ASAP project (LF 110nm)



Dual-readout Calorimetry

Millimeter scale, 2D monolithic silicon photomultipliers providing

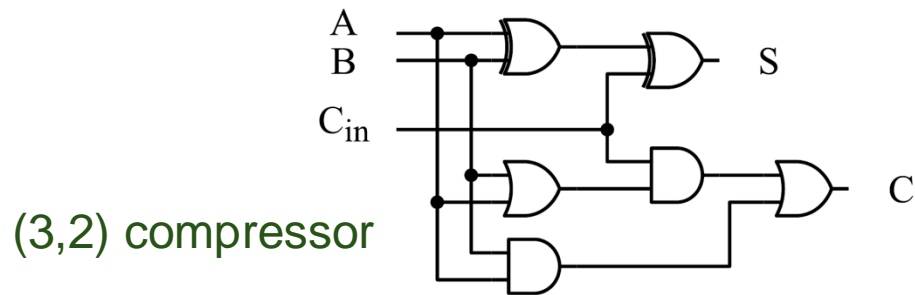
- **fully digital output** obtained through a completely digital processing chain (or, as a possible alternative, through current or charge integration and A/D conversion)
- **time of arrival** of the first bunch of photons and bunch duration with better than **100 ps** resolution
- **threshold adjustment** capabilities for noise rejection
- possibility of **individual micro-cell enabling**
- asynchronous counting over a more than three decade wide dynamic range of simultaneously firing micro-cells (order of a few thousands, **15/20 micron pitch**)

Integration of the sensing element and the processing electronics in the common substrate of a CMOS process is instrumental in accomplishing all of the above features

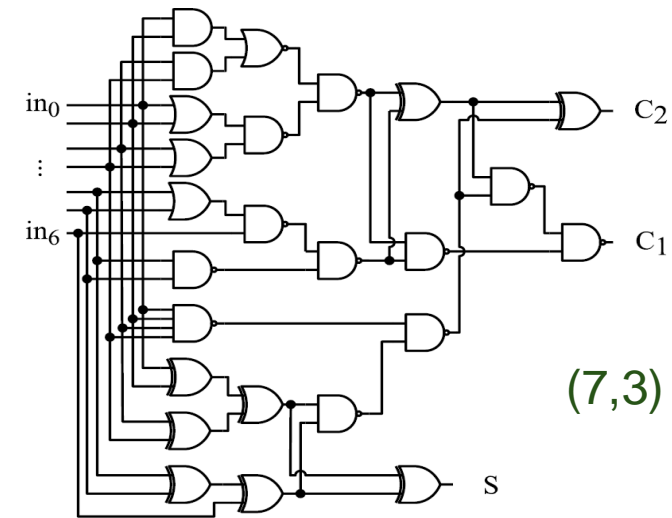
“A **Parallel Counter** is a combinational network which provides q outputs, processing the signals coming from its $p \leq 2^q - 1$ inputs. The binary number represented by the q outputs is the number of bits at 1 fed as inputs”

L. Dadda, “On Parallel Digital Multipliers”, Alta Frequenza, 1976

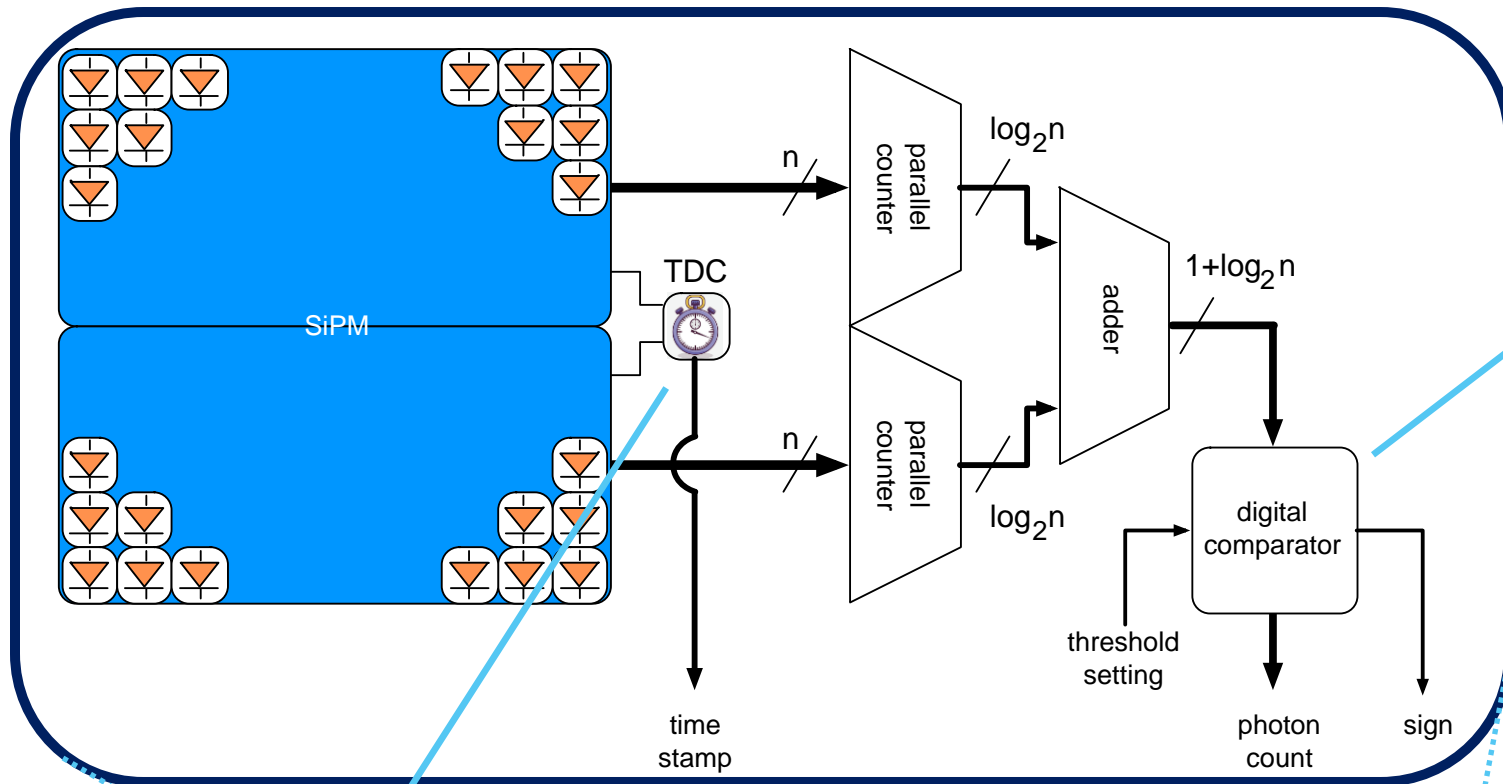
(n,m) compressors are devices capable of collapsing n input lines into m output lines interpreted as the binary representation of the number of ones at the input ($m \geq \lceil \log_2 n \rceil$)



| 2^{11} | 2^{10} | 2^9 | 2^8 | 2^7 | 2^6 | 2^5 | 2^4 | 2^3 | 2^2 | 2^1 | 2^0 | Binary Weight | | | | | |
|----------|----------|-------|-------|-------|-------|-----------|-----------|-----------|-----------|-----------|-----------|-------------------------|-------|-------|-------|-------|-------|
| | | | | | | y_5 | y_4 | y_3 | y_2 | y_1 | y_0 | Multiplicand Multiplier | | | | | |
| | | | | | | x_5 | x_4 | x_3 | x_2 | x_1 | x_0 | | | | | | |
| | | | | | | $x_0 y_5$ | $x_0 y_4$ | $x_0 y_3$ | $x_0 y_2$ | $x_0 y_1$ | $x_0 y_0$ | Partial Products | | | | | |
| | | | | | | $x_1 y_5$ | $x_1 y_4$ | $x_1 y_3$ | $x_1 y_2$ | $x_1 y_1$ | $x_1 y_0$ | | | | | | |
| | | | | | | $x_2 y_5$ | $x_2 y_4$ | $x_2 y_3$ | $x_2 y_2$ | $x_2 y_1$ | $x_2 y_0$ | | | | | | |
| | | | | | | $x_3 y_5$ | $x_3 y_4$ | $x_3 y_3$ | $x_3 y_2$ | $x_3 y_1$ | $x_3 y_0$ | | | | | | |
| | | | | | | $x_4 y_5$ | $x_4 y_4$ | $x_4 y_3$ | $x_4 y_2$ | $x_4 y_1$ | $x_4 y_0$ | Product | | | | | |
| | | | | | | $x_5 y_5$ | $x_5 y_4$ | $x_5 y_3$ | $x_5 y_2$ | $x_5 y_1$ | $x_5 y_0$ | | | | | | |
| | | | | | | p_{11} | p_{10} | p_9 | p_8 | p_7 | p_6 | p_5 | p_4 | p_3 | p_2 | p_1 | p_0 |



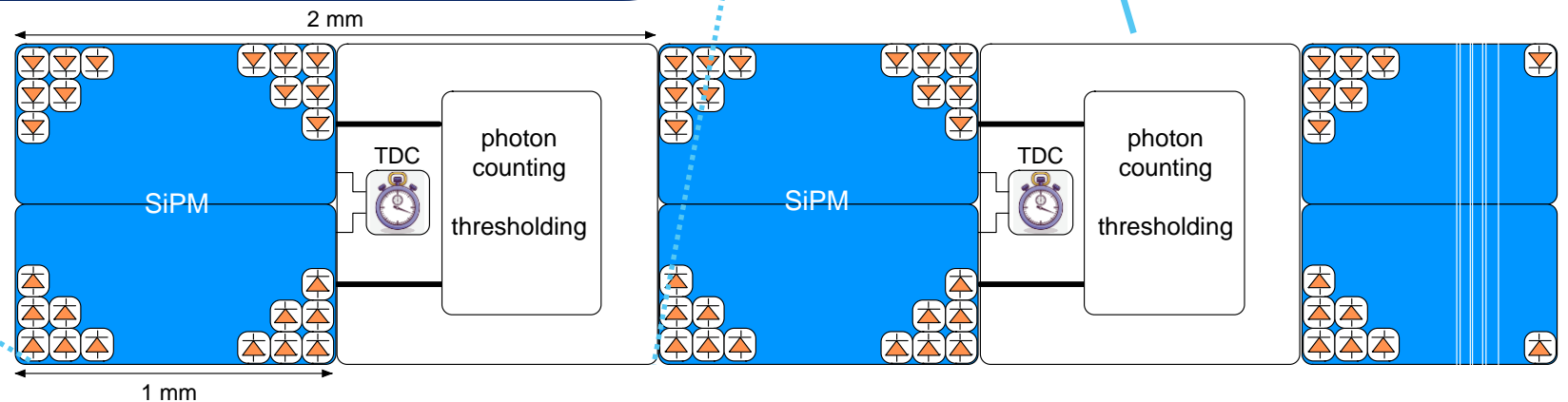
Mehta et al. 1991



thresholding - virtually any threshold might be set

electronics laid out in the inter-SiPM region, accommodating the capillary tubes

time stamping – close to the signal source, re-triggering TDC for signal duration



Small signal (RICH, DM, Neutrino)

Different specifications as compared to DR calorimetry

- **large SiPM area**, few to 10 mm side, but milder granularity requirements – better trade-off possible between functional density and PDE
- very small signal, setting some demanding specs on **dark count rate** – operation at low temperature for noise performance improvement

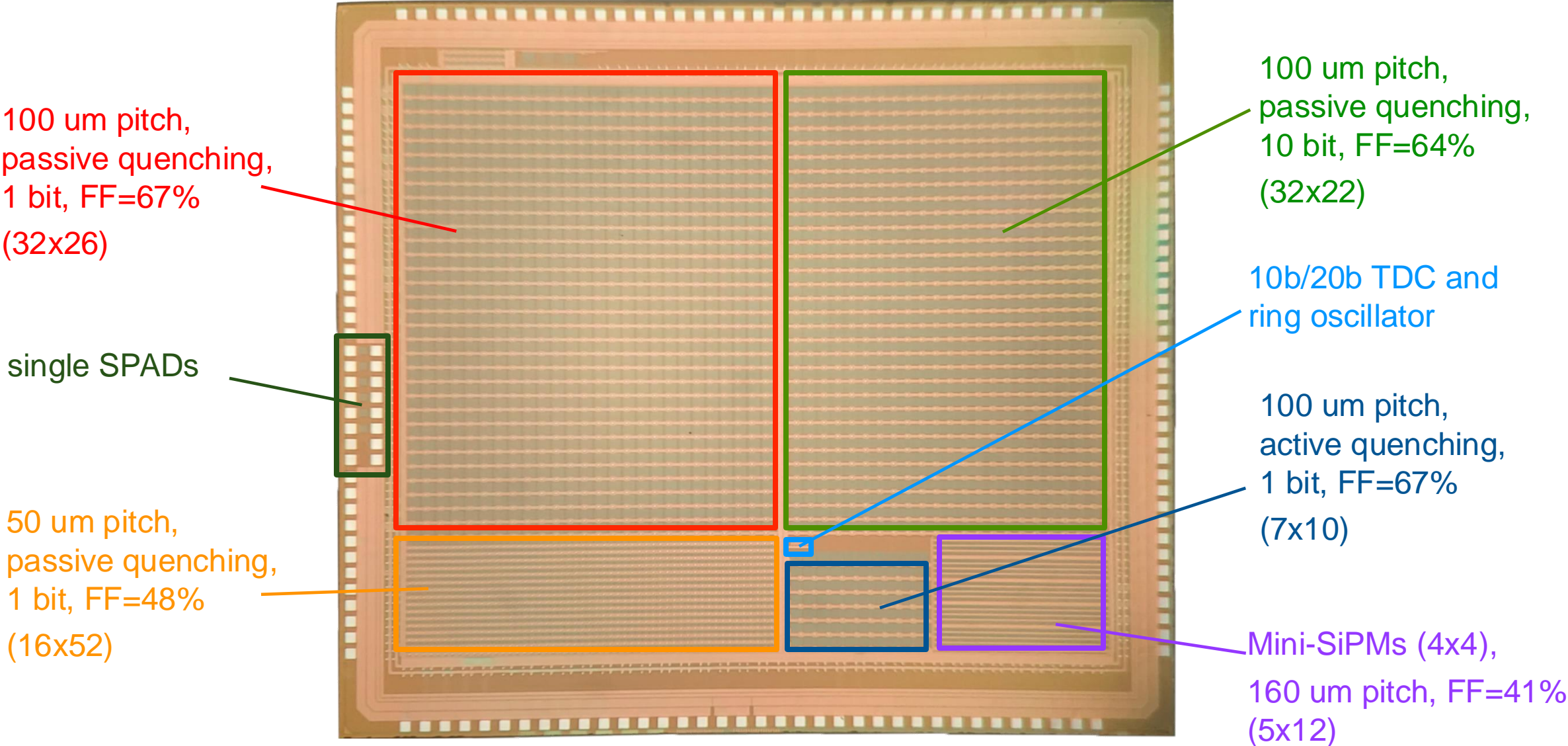
One of the ASPiDeS goals is the investigation of dSiPM operation in **cryogenic conditions**

- **modeling** of sensor behavior at LN temperature
- **modeling** of transistors and processing circuit behavior at cryogenic temperature

Improvement with decreasing temperature may be limited by BTB or TA tunneling

- **TCAD simulations** to optimize the sensor by reducing weakly temperature dependent contributions to DCR

ASAPLF110 chip – a technology characterization platform



Activity

2025:

- Characterization of the **ASAP110LF**
- Investigation of radiation damage and SPAD operation in cryogenic conditions

2026:

- Production of prototypes of CMOS SiPMs consisting of about 1000 SPADs with 15-20 μm pitch with on sensor electronics
- specific structures included to study the chip functionalities

2027:

- Development of a demonstrator with 8 SiPMs, each with a 1 mm^2 area and a 2 mm pitch (64x64 cells, 15 μm pitch) – dual readout calorimetry
- smaller versions of dSiPMs for application to **RICH**, **DM** and **neutrino** experiments (larger SPADs)
- Characterization in radioactive and cryogenic environment

Bologna is involved in the design (mainly in the digital part) and characterization. Possibilities to develop tailored devices